

INFLUENCE OF VOIDS ON THICK DCB JOINT BEHAVIOR

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Introduction

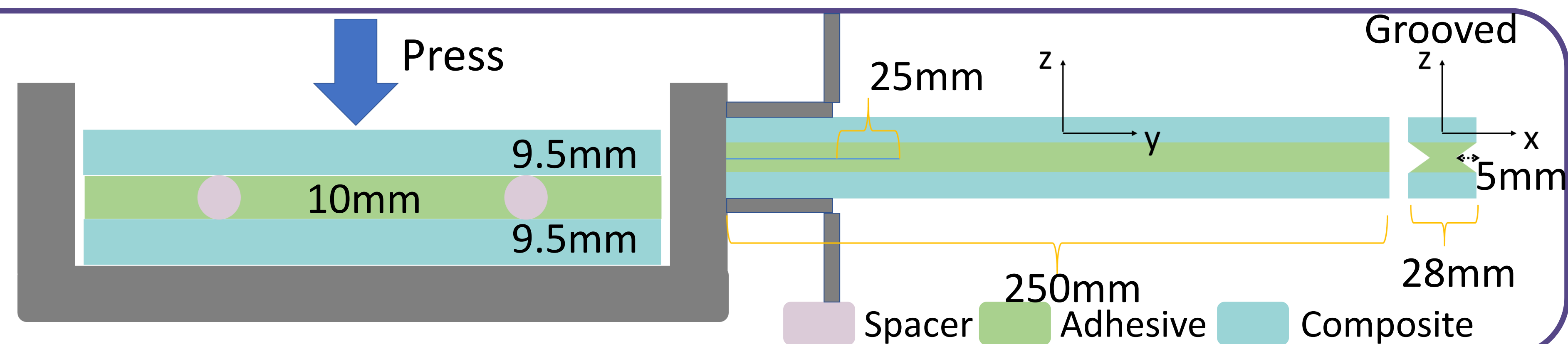
- The increasing length of wind turbine blades leads to the increase of adhesive use in bonded connections
- Adhesive joints in wind blades are much thicker than joints in other fields, reaching several cm, containing voids
- The shape and distribution of the voids influence the fracture behavior of the thick adhesive joints

Objectives

- Manufacturing thick DCB joints with different void contents and achieve cohesive failure
- Study the void content influence on the quasi-static Mode I fracture behavior

Materials and manufacturing

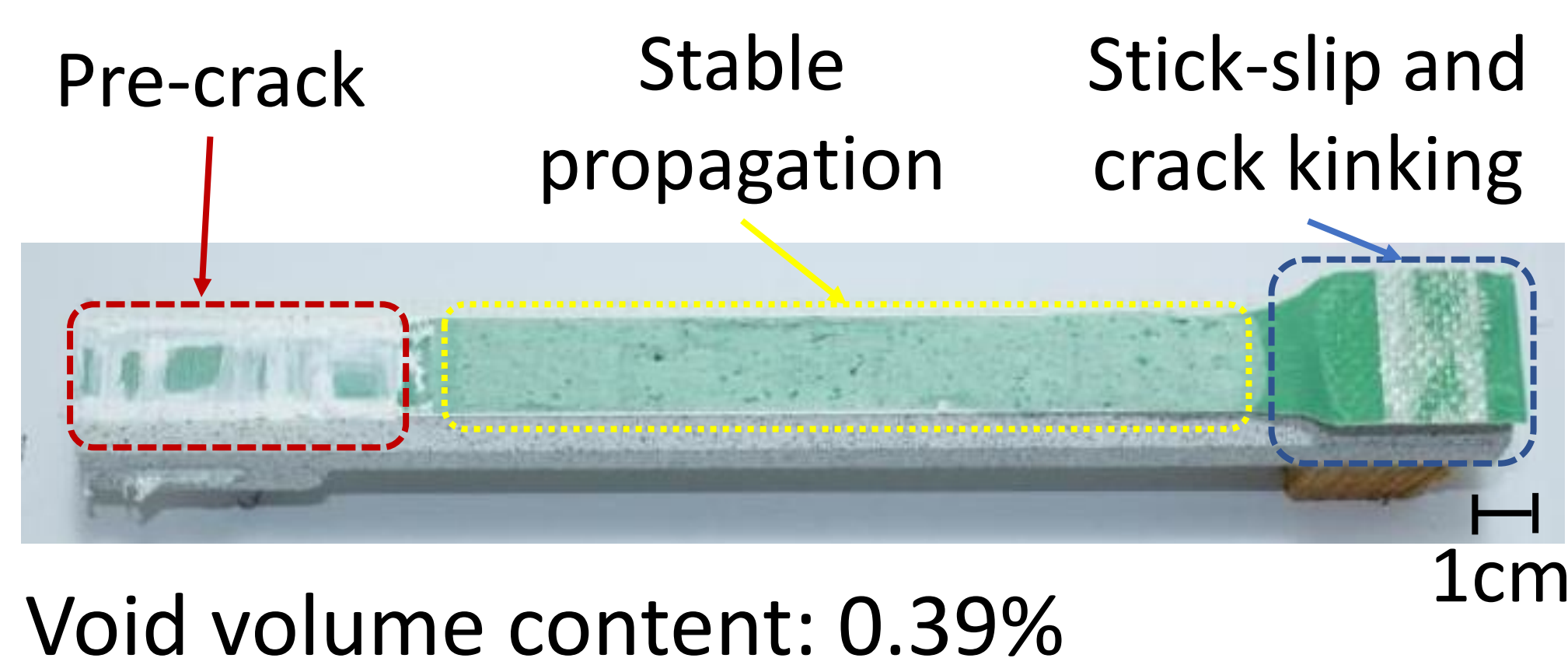
- Adherend: $[90/0]_{7s}$ cross-ply composite
- Adhesive: High viscous SikaPower®-830
- Thickness control by spacers and pressing
- Grooved geometry



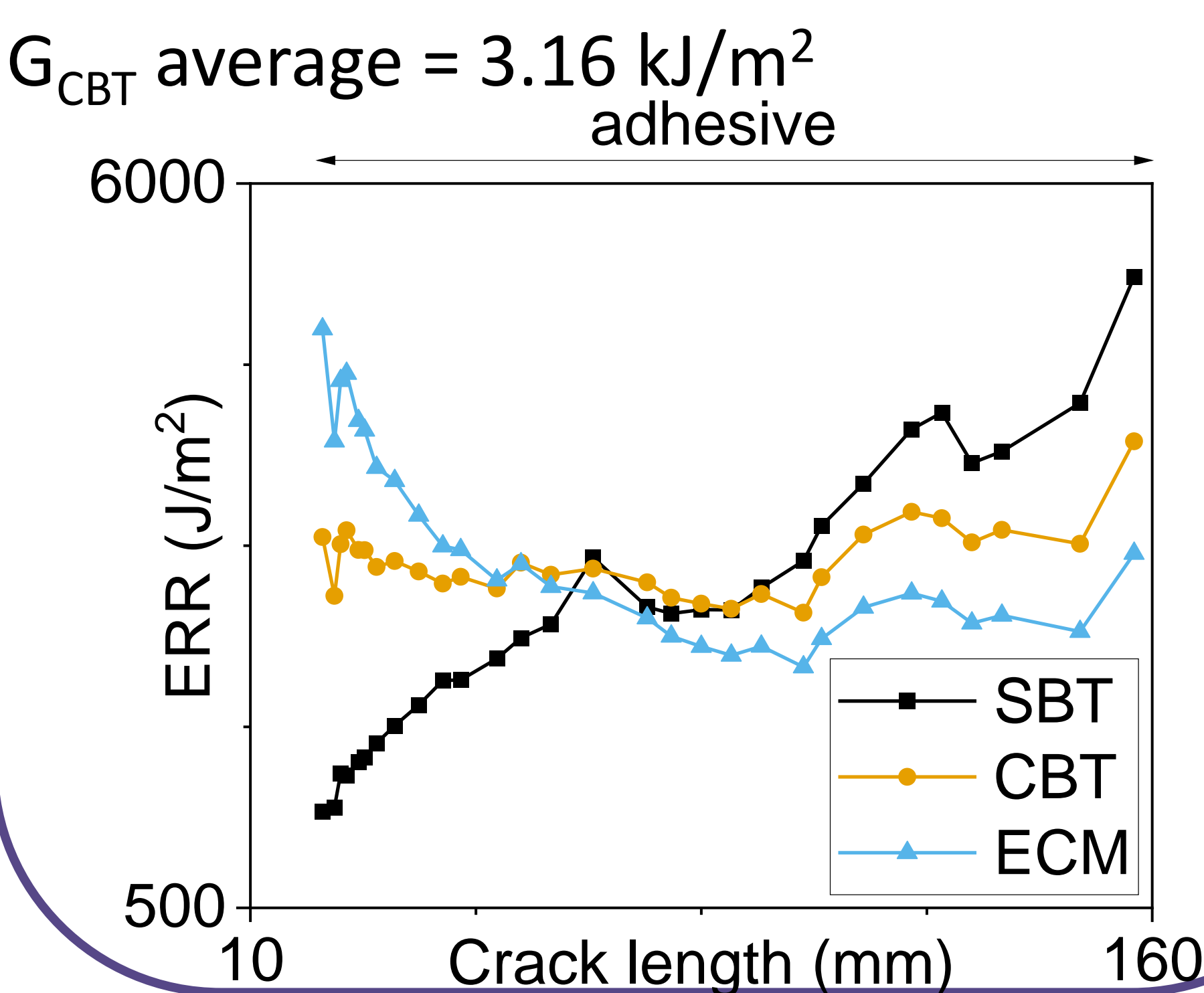
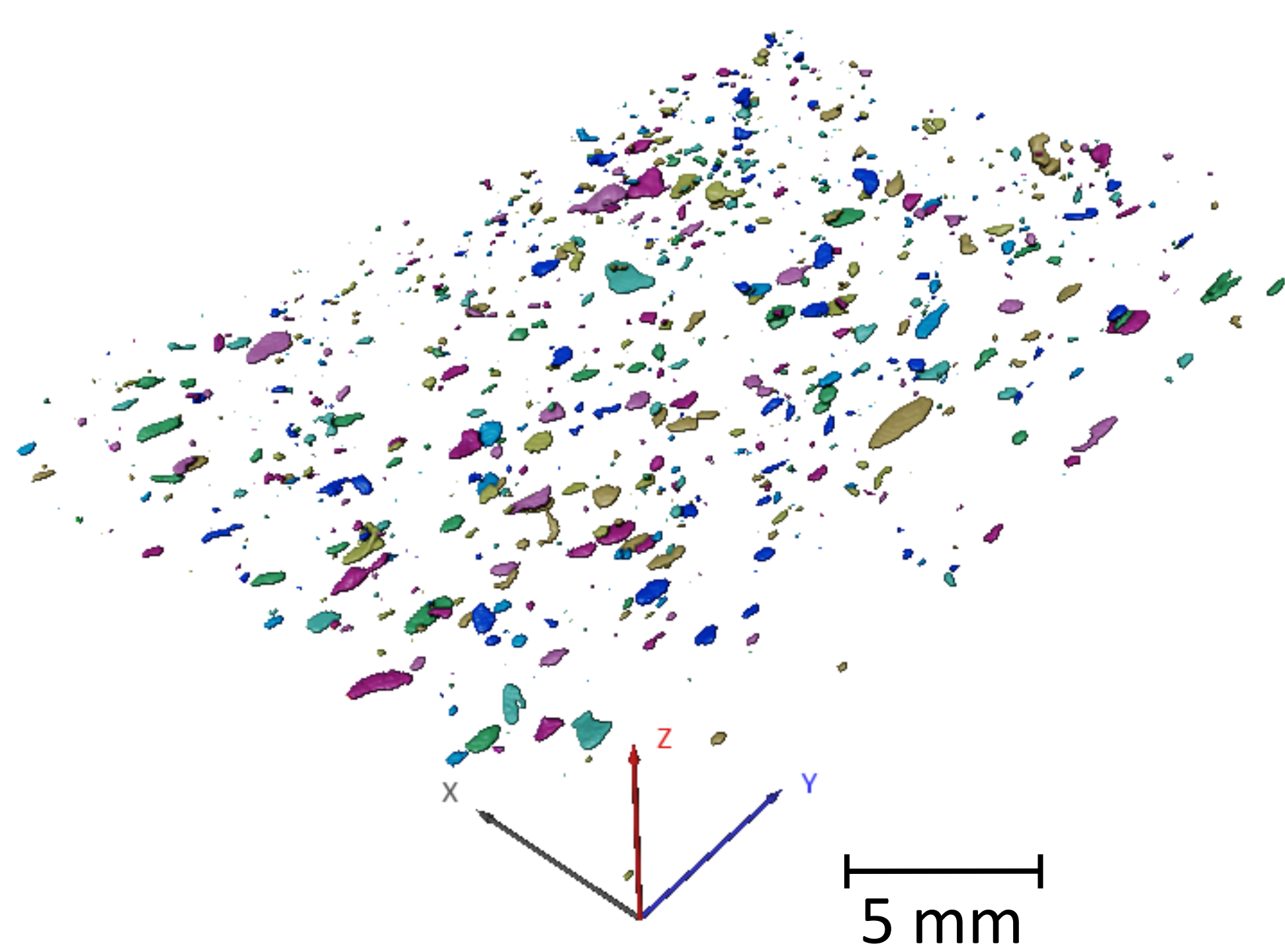
Tests and Results

- Results shows below with fracture surface, X-ray scanning void distribution picture and ERR curves
- Stick-slip propagation: unstable propagation with fracture surface color change
- Crack kinking: crack propagation direction changes

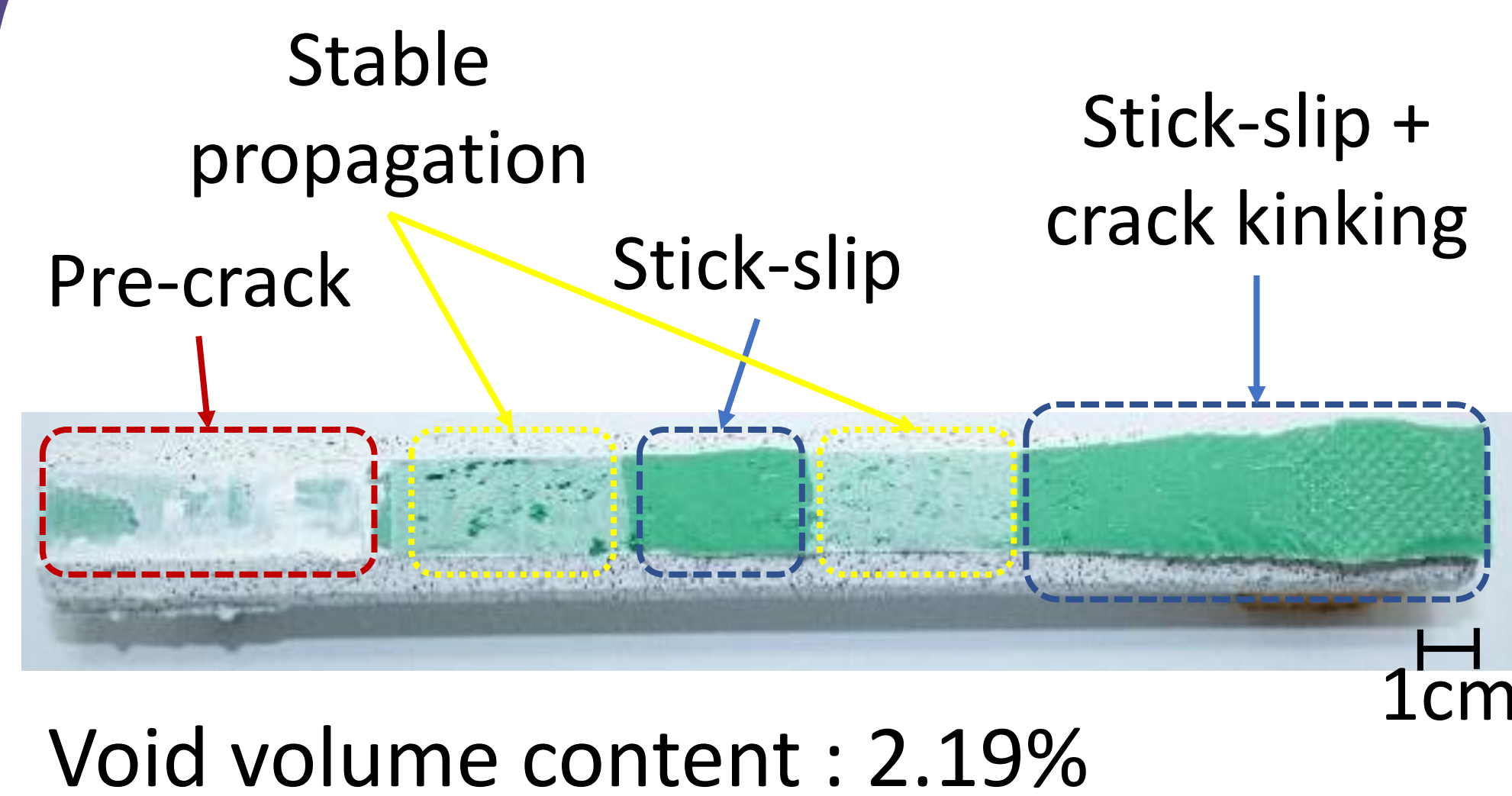
Low void content



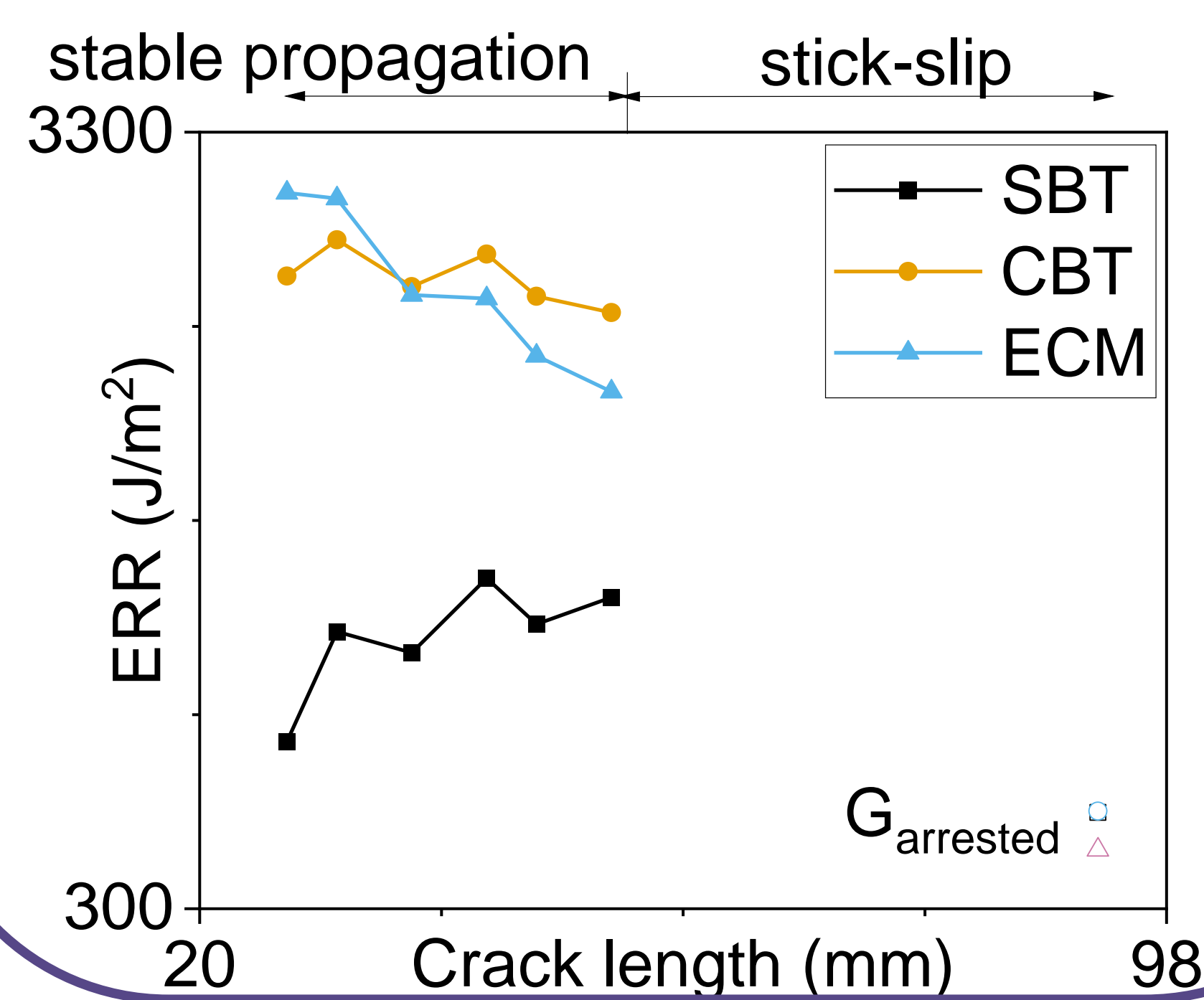
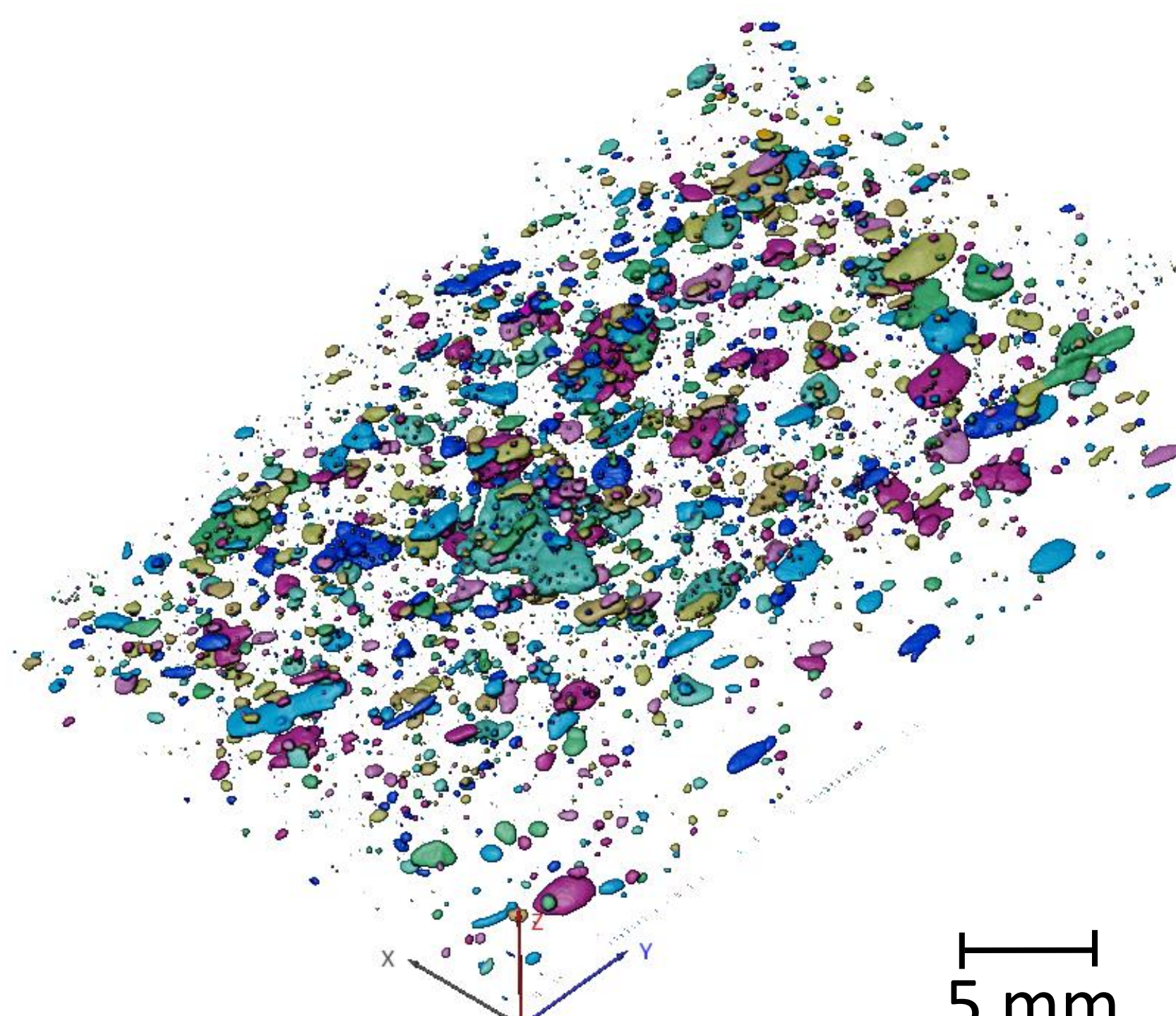
Void volume content: 0.39%



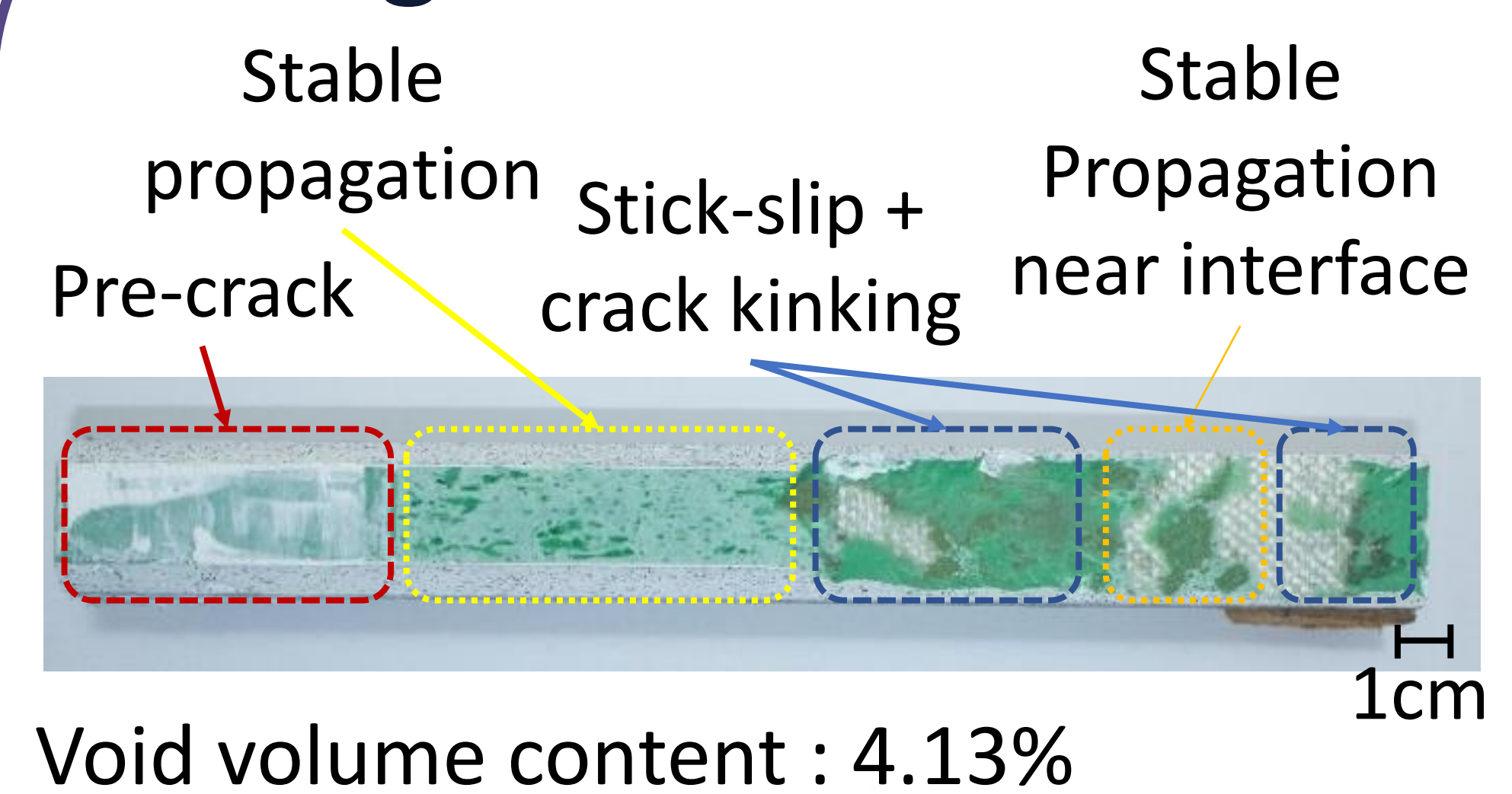
Medium void content



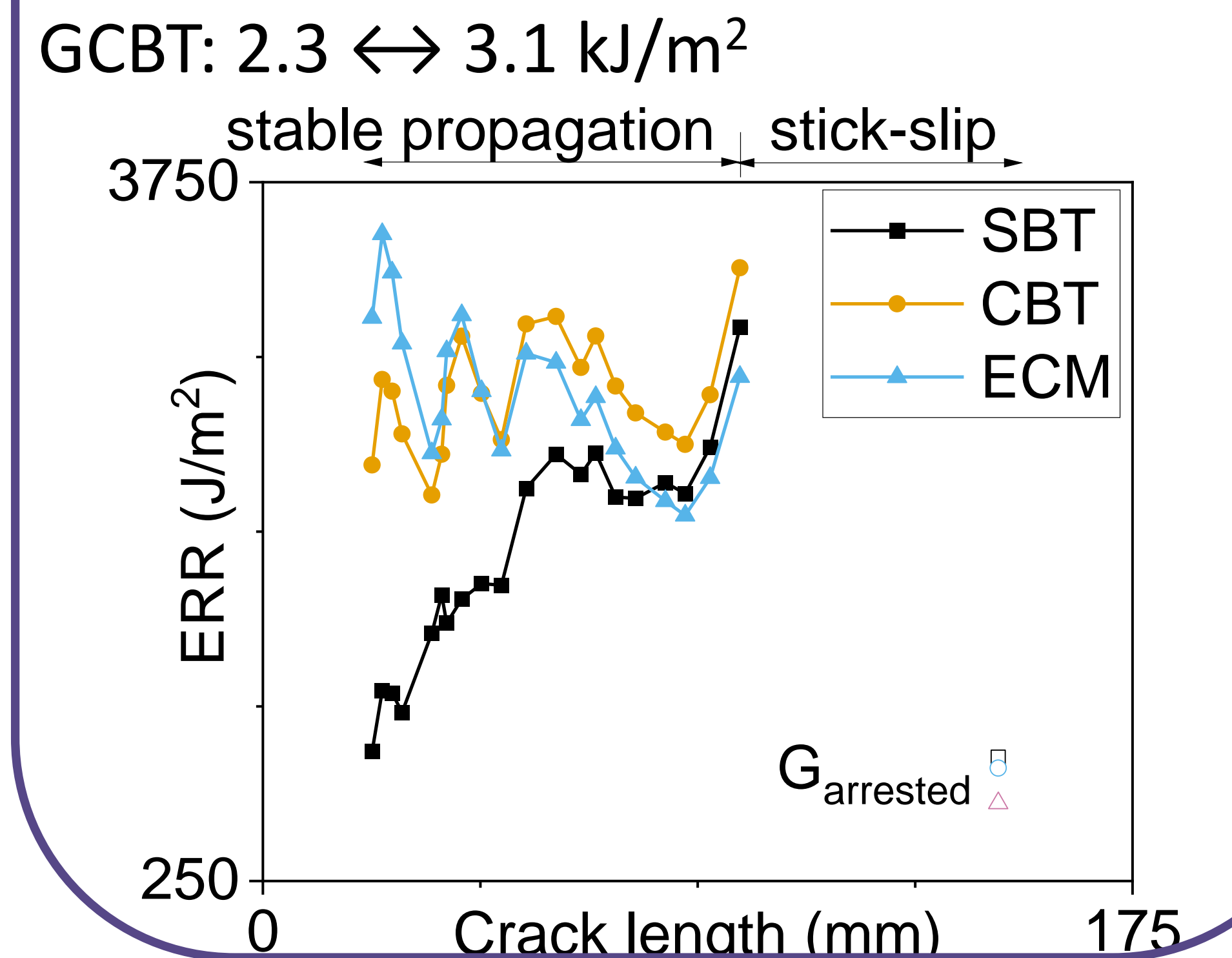
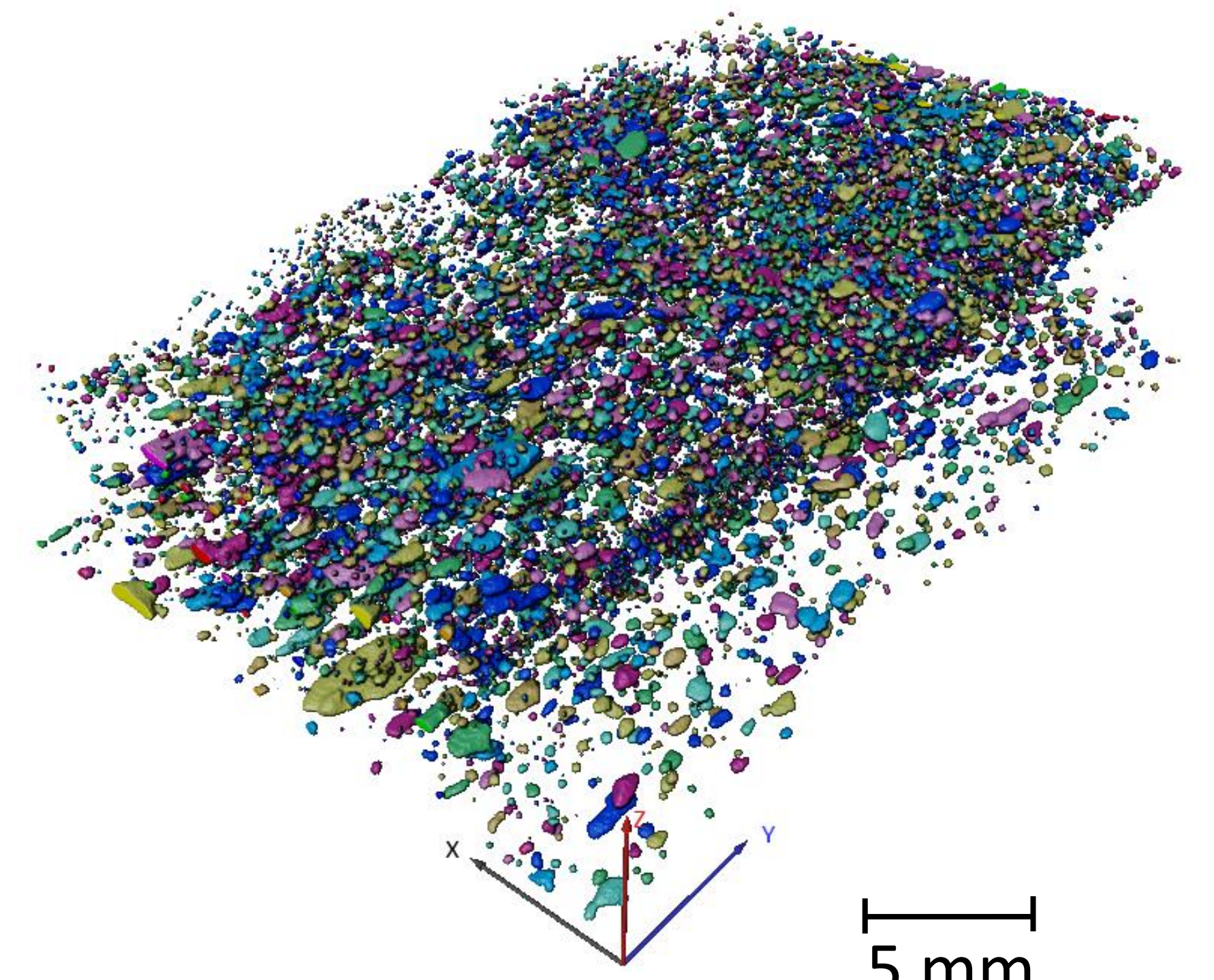
Void volume content : 2.19%



Large void content



Void volume content : 4.13%



Conclusion

- Voids always exist within thick adhesive layers and large voids ahead of the crack tip can lead to unstable crack propagation
- Small void content is beneficial for stable crack propagation without crack kinking
- Large void content can result in fluctuating ERR curve or more complicated behavior
- Fracture will prefer to choose the path with voids, which consumes less energy